LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: http://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER :		
MODULE NO.:	WG12864B-Y	YYH-V#N
APPROVED BY:		
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
E	2014/04/14		Correct Luminance.



DOC. FIRST ISSUE **RECORDS OF REVISION REVISED** VERSION **DATE SUMMARY** PAGE NO. 2007/01/15 First issue 0 2009/02/26 **Correct Timing** Characteristics B 2010/03/02 Modify View area, Active area C Modify backlight 2012/08/22 information. 2013/04/02 Correct contour drawing D Modify IC information

Correct Luminance.

2014/04/14

E

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1. Module Classification Information

W	<u>G</u>	<u>12864</u>	<u>B</u>	_	<u>Y</u>	<u>Y</u>	<u>H</u>	_	<u>V#N</u>
1	2	3	4		(5)	6	7		8

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

3 Display Font: 128 * 64 dot

Model serials no.

 \bigcirc Backlight Type : N \rightarrow Without backlight T \rightarrow LED, White S \rightarrow LED, High light White

 $B \rightarrow EL$, Blue green $A \rightarrow LED$, Amber $L \rightarrow LED$, Full color $D \rightarrow EL$, Green $R \rightarrow LED$, Red $J \rightarrow DIP$ LED, Blue $W \rightarrow EL$, White $O \rightarrow LED$, Orange $K \rightarrow DIP$ LED, White

 $M\rightarrow EL$, Yellow Green $G\rightarrow LED$, Green $E\rightarrow DIP$ LED, Yellow Green

F \rightarrow CCFL, White P \rightarrow LED, Blue H \rightarrow DIP LED, Amber Y \rightarrow LED, Yellow Green X \rightarrow LED, Dual color I \rightarrow DIP LED, Red

 $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V: Build in Negative Voltage

#:Fit in with the ROHS Directions and regulations

N: IC NT7107.NT7108

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)

3.General Specification

Item	Dimension	Unit					
Number of dots	128 x 64	_					
Module dimension	75.0 x 52.7 x 8.9 (MAX)	mm					
View area	58.8 x 31.4	mm					
Active area	55.01 x 27.49	mm					
Dot size	0.40 x 0.40	mm					
Dot pitch	0.43 x 0.43	mm					
LCD type	STN Positive, Yellow Green Transflective (In LCD production, It will occur slightly color can only guarantee the same color in the same be						
Duty	1/64						
View direction	6 o'clock	6 o'clock					
Backlight Type	LED, Yellow Green	LED, Yellow Green					
IC	NT7107, NT7108	NT7107, NT7108					

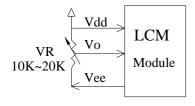
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	V_{DD} - V_{SS}	-0.3		7.0	V
Driver Supply Voltage	$ m V_{LCD}$	V _{EE} -0.3	_	V _{DD} +0.3	V

5.Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	9.6	V
LCD	V_{DD} - V_{O}	Ta=25°℃	7.8	8.0	8.2	V
*Note		Ta=70°C	7.6	_	_	V
Input High Volt.	V_{IH}	_	$0.7~\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	0	_	0.8	V
Output High Volt.	V_{OH}	_	2.4	_	_	V
Output Low Volt.	V _{OL}	_		_	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	3.0	4.0	5.0	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

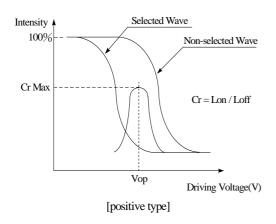


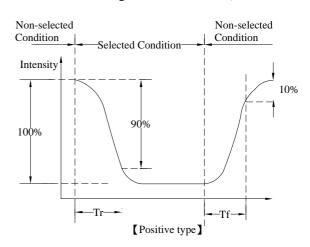
6.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
N A I .	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	ϕ = 270°
Contrast Ratio	CR	_	—	3	—	_
D	T rise	_	—	150	200	ms
Response Time	T fall	_	_	150	200	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)



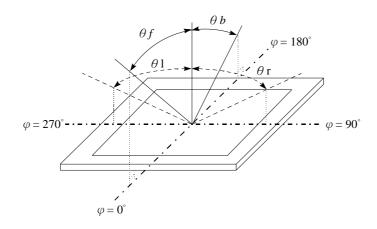


Conditions:

Operating Voltage : Vop Viewing Angle(θ , φ) : 0° , 0°

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

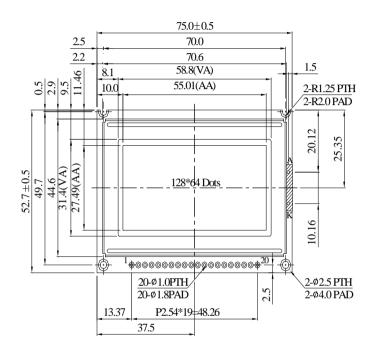
Definition of viewing angle ($CR \ge 2$)

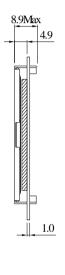


7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	Vdd	5.0V	Supply voltage for logic
2	V_{SS}	0V	Ground
3	V _o	(Variable)	Contrast Adjustment
4	DB0	H/L	Data bus line
5	DB1	H/L	Data bus line
6	DB2	H/L	Data bus line
7	DB3	H/L	Data bus line
8	DB4	H/L	Data bus line
9	DB5	H/L	Data bus line
10	DB6	H/L	Data bus line
11	DB7	H/L	Data bus line
12	CS1	L	Select Column 1~ Column 64
13	CS2	L	Select Column 65~ Column 128
14	/RST	L	Reset signal
15	R/W	H/L	H: Read (MPU←Module) , L: Write (MPU→Module)
16	D/I	H/L	H: Data, L: Instruction
17	Е	Н	Enable signal
18	Vee	_	Negative Voltage output
19	A	—	Power Supply for LED backlight (+)
20	K	_	Power Supply for LED backlight (-)

8.Contour Drawing & Block Diagram

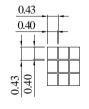




LEDB/L

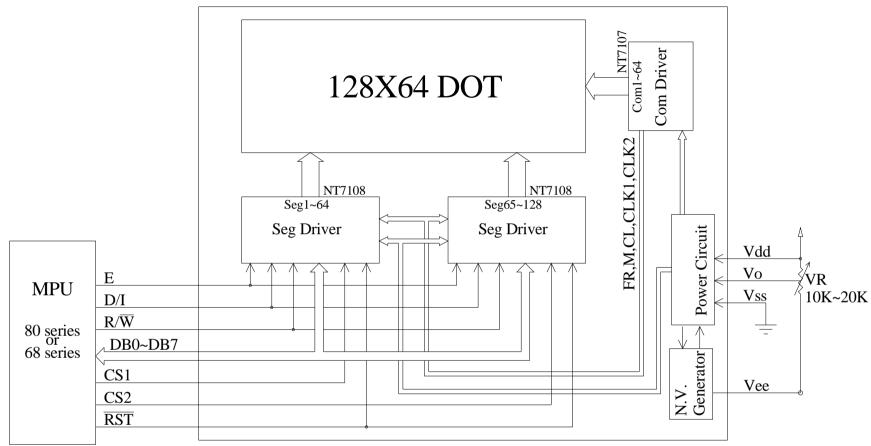
PIN NO.	SYMBOL			
1	Vdd			
2	Vss			
3	Vo			
4	DB0			
5	DB1			
6	DB2			
7	DB3			
8	DB4			
9	DB5			
10	DB6			
11	DB7			
12	CS1			
13	CS2			
14	RST			
15	R/\overline{W}			
16	D/\bar{I}			
17	E			
18	Vee			
19	A			
20	K			

DDIANO GYD CD OX



DOT SIZE SCALE 10/1 The non-specified tolerance of dimension is (15).3 mm.

WG12864B-YYH-V#N



External contrast adjustment.

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test						
Test Item	Content of Test	Test Condition	Note			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles				
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time				

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

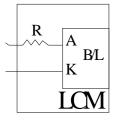
10.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	80	100	120	mA	V=4.2V
Supply Voltage	V	3.9	4.2	4.4	V	_
Reverse Voltage	VR	_	_	8	V	_
Luminance (Without LCD)	IV	34	42.5	_	CD/M ²	ILED=100mA
Wave Length	λp	569	571	574	nm	ILED=100mA
Life Time	_	_	50000	_	Hr.	ILED≤100mA 25℃,50-60%RH
Color	Yellow Gre	een	- 1	•	- 1	,

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Drive frompin19,pin20



11.Inspection specification

NO	Item	Criterion			AQL	
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.			0.65	
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 		2.5		
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type:	↓ ▼ Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are v judge using blace specifications, to to find, must che specify direction	ck spot not easy neck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion			AQL	
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
		Symbols Define:				
		x: Chip length y	z: Chip width z: Ch	nip thickness		
		k: Seal width t	: Glass thickness a: LO	CD side length		
		L: Electrode pad lengtl	n:			
		6.1 General glass chip				
		6.1.1 Chip on panel sur	rface and crack between	panels:		
			N N N N N N N N N N N N N N N N N N N			
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing	x ≤ 1/8a		
06	Chipped		area		2.5	
	glass		Not exceed 1/3k	$x \le 1/8a$		
		6.1.2 Corner crack:	e chips, x is total length	of each chip.		
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	x ≤ 1/8a		
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a		
		⊙ If there are 2 or mor	e chips, x is the total ler	ngth of each chip.		

NO	Item	Criterion			AQL	
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:				
			≤1/8a	z: Chip thickness $0 < z \le t$		
06	Glass	y X	L 12 y	1 Z	2.5	
		y: Chip width	x: Chip length	z: Chip thickness		
		y≦ L	x ≤ 1/8a	$0 < z \le t$		
		 ⊙ If the chipped area touch remain and be inspected as ⊙ If the product will be here be damaged. 6.2.3 Substrate protuberance 	cording to electrode to at sealed by the custon			

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5
10	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB	2.5 2.5 0.65 2.5 0.65 2.5 2.5 2.5 2.5 2.5 2.5 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	Comonal	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12	General appearance	component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp.:

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}\mathbb{C}$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

winstar <u>LCM Samp</u> dule Number :		Feedback Sheet Page: 1	
1 · Panel Specification :			
1. Panel Type:	Pass	□ NG ,	
2. View Direction:	Pass	□ NG ,	
3. Numbers of Dots:	Pass	□ NG ,	
4. View Area:	Pass	□ NG ,	
5. Active Area:	Pass	□ NG ,	
6. Operating Temperature:	Pass	☐ NG ,	
7. Storage Temperature:	Pass	□ NG ,	
8. Others:			
2 · Mechanical Specification :			
1. PCB Size:	Pass	□ NG ,	
2. Frame Size:	Pass	☐ NG ,	
3. Materal of Frame:	Pass	□ NG ,	
4. Connector Position:	Pass	□ NG ,	
5. Fix Hole Position:	Pass	□ NG ,	
6. Backlight Position:	Pass	□ NG ,	
7. Thickness of PCB:	Pass	□ NG ,	
8. Height of Frame to PCB:	Pass	□ NG ,	
9. Height of Module:	Pass	□ NG ,	
10. Others:	Pass	□ NG ,	
3 · <u>Relative Hole Size</u> :			
1. Pitch of Connector:	Pass	☐ NG ,	
2. Hole size of Connector:	Pass	☐ NG ,	
3. Mounting Hole size:	Pass	☐ NG ,	
4. Mounting Hole Type:	Pass	☐ NG ,	
5. Others:	Pass	☐ NG ,	
4 · <u>Backlight Specification</u> :			
1. B/L Type:	Pass	□ NG ,	
2. B/L Color:	Pass	□ NG ,	
3. B/L Driving Voltage (Refere	nce for LED		
4. B/L Driving Current:	Pass	☐ NG ,	
5. Brightness of B/L:	Pass	□ NG ,	
6. B/L Solder Method:	Pass	□ NG ,	
7. Others:	Pass	☐ NG ,	



	winstar				
Modu	le Number:		Page: 2		
5、	Electronic Characteristics of	Module:			
1.	Input Voltage:	Pass	☐ NG ,		
2.	Supply Current:	Pass	☐ NG ,		
3.	Driving Voltage for LCD:	Pass	☐ NG ,		
4.	Contrast for LCD:	Pass	□ NG ,		
5.	B/L Driving Method:	Pass	☐ NG ,		
6.	Negative Voltage Output:	Pass	☐ NG ,		
7.	Interface Function:	Pass	□ NG ,		
8.	LCD Uniformity:	Pass	☐ NG ,		
9.	ESD test:	Pass	☐ NG ,		
10.	Others:	Pass	□ NG ,		
6、	Summary:				
	Sales signature:				
	Customer Signature :		Date : / /		
			• •		